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### Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

### Applications of Embedded - CPLDs

#### Details

Product Status	Active
Programmable Type	In System Programmable
Delay Time tpd(1) Max	5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	4
Number of Macrocells	64
Number of Gates	-
Number of I/O	30
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4064v-5tn44c">https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4064v-5tn44c</a>

## Product Term Allocator

The product term allocator assigns product terms from a cluster to either logic or control applications as required by the design being implemented. Product terms that are used as logic are steered into a 5-input OR gate associated with the cluster. Product terms that used for control are steered either to the macrocell or I/O cell associated with the cluster. Table 3 shows the available functions for each of the five product terms in the cluster. The OR gate output connects to the associated I/O cell, providing a fast path for narrow combinatorial functions, and to the logic allocator.

**Table 3. Individual PT Steering**

Product Term	Logic	Control
PT $n$	Logic PT	Single PT for XOR/OR
PT $n+1$	Logic PT	Individual Clock (PT Clock)
PT $n+2$	Logic PT	Individual Initialization or Individual Clock Enable (PT Initialization/CE)
PT $n+3$	Logic PT	Individual Initialization (PT Initialization)
PT $n+4$	Logic PT	Individual OE (PTOE)

## Cluster Allocator

The cluster allocator allows clusters to be steered to neighboring macrocells, thus allowing the creation of functions with more product terms. Table 4 shows which clusters can be steered to which macrocells. Used in this manner, the cluster allocator can be used to form functions of up to 20 product terms. Additionally, the cluster allocator accepts inputs from the wide steering logic. Using these inputs, functions up to 80 product terms can be created.

**Table 4. Available Clusters for Each Macrocell**

Macrocell	Available Clusters			
M0	—	C0	C1	C2
M1	C0	C1	C2	C3
M2	C1	C2	C3	C4
M3	C2	C3	C4	C5
M4	C3	C4	C5	C6
M5	C4	C5	C6	C7
M6	C5	C6	C7	C8
M7	C6	C7	C8	C9
M8	C7	C8	C9	C10
M9	C8	C9	C10	C11
M10	C9	C10	C11	C12
M11	C10	C11	C12	C13
M12	C11	C12	C13	C14
M13	C12	C13	C14	C15
M14	C13	C14	C15	—
M15	C14	C15	—	—

## Wide Steering Logic

The wide steering logic allows the output of the cluster allocator  $n$  to be connected to the input of the cluster allocator  $n+4$ . Thus, cluster chains can be formed with up to 80 product terms, supporting wide product term functions and allowing performance to be increased through a single GLB implementation. Table 5 shows the product term chains.

- Block CLK2
- Block CLK3
- PT Clock
- PT Clock Inverted
- Shared PT Clock
- Ground

### Clock Enable Multiplexer

Each macrocell has a 4:1 clock enable multiplexer. This allows the clock enable signal to be selected from the following four sources:

- PT Initialization/CE
- PT Initialization/CE Inverted
- Shared PT Clock
- Logic High

### Initialization Control

The ispMACH 4000 family architecture accommodates both block-level and macrocell-level set and reset capability. There is one block-level initialization term that is distributed to all macrocell registers in a GLB. At the macrocell level, two product terms can be “stolen” from the cluster associated with a macrocell to be used for set/reset functionality. A reset/preset swapping feature in each macrocell allows for reset and preset to be exchanged, providing flexibility.

Note that the reset/preset swapping selection feature affects power-up reset as well. All flip-flops power up to a known state for predictable system initialization. If a macrocell is configured to SET on a signal from the block-level initialization, then that macrocell will be SET during device power-up. If a macrocell is configured to RESET on a signal from the block-level initialization or is not configured for set/reset, then that macrocell will RESET on power-up. To guarantee initialization values, the  $V_{CC}$  rise must be monotonic, and the clock must be inactive until the reset delay time has elapsed.

### GLB Clock Generator

Each ispMACH 4000 device has up to four clock pins that are also routed to the GRP to be used as inputs. These pins drive a clock generator in each GLB, as shown in Figure 6. The clock generator provides four clock signals that can be used anywhere in the GLB. These four GLB clock signals can consist of a number of combinations of the true and complement edges of the global clock signals.

**Figure 6. GLB Clock Generator**

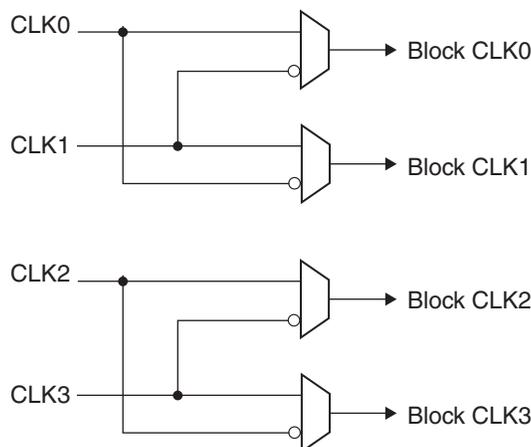
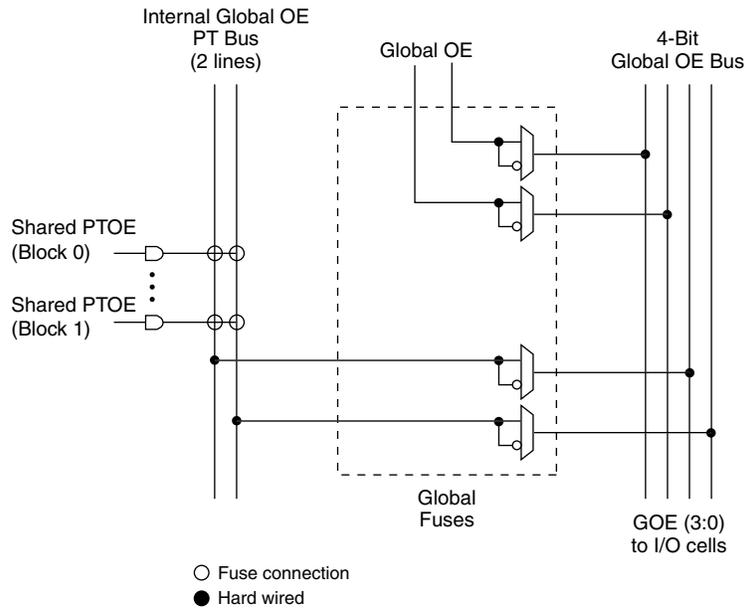


Figure 10. Global OE Generation for ispMACH 4032



## Zero Power/Low Power and Power Management

The ispMACH 4000 family is designed with high speed low power design techniques to offer both high speed and low power. With an advanced  $E^2$  low power cell and non sense-amplifier design approach (full CMOS logic approach), the ispMACH 4000 family offers SuperFAST pin-to-pin speeds, while simultaneously delivering low standby power without needing any “turbo bits” or other power management schemes associated with a traditional sense-amplifier approach.

The zero power ispMACH 4000Z is based on the 1.8V ispMACH 4000C family. With innovative circuit design changes, the ispMACH 4000Z family is able to achieve the industry’s “lowest static power”.

## IEEE 1149.1-Compliant Boundary Scan Testability

All ispMACH 4000 devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board-level testing. The test access port operates with an LVCMOS interface that corresponds to the power supply voltage.

## I/O Quick Configuration

To facilitate the most efficient board test, the physical nature of the I/O cells must be set before running any continuity tests. As these tests are fast, by nature, the overhead and time that is required for configuration of the I/Os’ physical nature should be minimal so that board test time is minimized. The ispMACH 4000 family of devices allows this by offering the user the ability to quickly configure the physical nature of the I/O cells. This quick configuration takes milliseconds to complete, whereas it takes seconds for the entire device to be programmed. Lattice’s ispVM<sup>®</sup> System programming software can either perform the quick configuration through the PC parallel port, or can generate the ATE or test vectors necessary for a third-party test system.

## Supply Current, ispMACH 4000V/B/C

## Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
<b>ispMACH 4032V/B/C</b>						
ICC <sup>1,2,3</sup>	Operating Power Supply Current	V <sub>CC</sub> = 3.3V	—	11.8	—	mA
		V <sub>CC</sub> = 2.5V	—	11.8	—	mA
		V <sub>CC</sub> = 1.8V	—	1.8	—	mA
ICC <sup>4</sup>	Standby Power Supply Current	V <sub>CC</sub> = 3.3V	—	11.3	—	mA
		V <sub>CC</sub> = 2.5V	—	11.3	—	mA
		V <sub>CC</sub> = 1.8V	—	1.3	—	mA
<b>ispMACH 4064V/B/C</b>						
ICC <sup>1,2,3</sup>	Operating Power Supply Current	V <sub>CC</sub> = 3.3V	—	12	—	mA
		V <sub>CC</sub> = 2.5V	—	12	—	mA
		V <sub>CC</sub> = 1.8V	—	2	—	mA
ICC <sup>5</sup>	Standby Power Supply Current	V <sub>CC</sub> = 3.3V	—	11.5	—	mA
		V <sub>CC</sub> = 2.5V	—	11.5	—	mA
		V <sub>CC</sub> = 1.8V	—	1.5	—	mA
<b>ispMACH 4128V/B/C</b>						
ICC <sup>1,2,3</sup>	Operating Power Supply Current	V <sub>CC</sub> = 3.3V	—	12	—	mA
		V <sub>CC</sub> = 2.5V	—	12	—	mA
		V <sub>CC</sub> = 1.8V	—	2	—	mA
ICC <sup>4</sup>	Standby Power Supply Current	V <sub>CC</sub> = 3.3V	—	11.5	—	mA
		V <sub>CC</sub> = 2.5V	—	11.5	—	mA
		V <sub>CC</sub> = 1.8V	—	1.5	—	mA
<b>ispMACH 4256V/B/C</b>						
I <sub>CC</sub> <sup>1,2,3</sup>	Operating Power Supply Current	V <sub>CC</sub> = 3.3V	—	12.5	—	mA
		V <sub>CC</sub> = 2.5V	—	12.5	—	mA
		V <sub>CC</sub> = 1.8V	—	2.5	—	mA
I <sub>CC</sub> <sup>4</sup>	Standby Power Supply Current	V <sub>CC</sub> = 3.3V	—	12	—	mA
		V <sub>CC</sub> = 2.5V	—	12	—	mA
		V <sub>CC</sub> = 1.8V	—	2	—	mA
<b>ispMACH 4384V/B/C</b>						
I <sub>CC</sub> <sup>1,2,3</sup>	Operating Power Supply Current	V <sub>CC</sub> = 3.3V	—	13.5	—	mA
		V <sub>CC</sub> = 2.5V	—	13.5	—	mA
		V <sub>CC</sub> = 1.8V	—	3.5	—	mA
I <sub>CC</sub> <sup>4</sup>	Standby Power Supply Current	V <sub>CC</sub> = 3.3V	—	12.5	—	mA
		V <sub>CC</sub> = 2.5V	—	12.5	—	mA
		V <sub>CC</sub> = 1.8V	—	2.5	—	mA
<b>ispMACH 4512V/B/C</b>						
I <sub>CC</sub> <sup>1,2,3</sup>	Operating Power Supply Current	V <sub>CC</sub> = 3.3V	—	14	—	mA
		V <sub>CC</sub> = 2.5V	—	14	—	mA
		V <sub>CC</sub> = 1.8V	—	4	—	mA

## ispMACH 4000Z External Switching Characteristics (Cont.)

Over Recommended Operating Conditions

Parameter	Description <sup>1, 2, 3</sup>	-45		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PD</sub>	5-PT bypass combinatorial propagation delay	—	4.5	—	5.0	—	7.5	ns
t <sub>PD_MC</sub>	20-PT combinatorial propagation delay through macrocell	—	5.8	—	6.0	—	8.0	ns
t <sub>S</sub>	GLB register setup time before clock	2.9	—	3.0	—	4.5	—	ns
t <sub>ST</sub>	GLB register setup time before clock with T-type register	3.1	—	3.2	—	4.7	—	ns
t <sub>SIR</sub>	GLB register setup time before clock, input register path	1.3	—	1.3	—	1.4	—	ns
t <sub>SIRZ</sub>	GLB register setup time before clock with zero hold	2.6	—	2.6	—	2.7	—	ns
t <sub>H</sub>	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	ns
t <sub>HT</sub>	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	ns
t <sub>HIR</sub>	GLB register hold time after clock, input register path	1.3	—	1.3	—	1.3	—	ns
t <sub>HIRZ</sub>	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	ns
t <sub>CO</sub>	GLB register clock-to-output delay	—	3.8	—	4.2	—	4.5	ns
t <sub>R</sub>	External reset pin to output delay	—	7.5	—	7.5	—	9.0	ns
t <sub>RW</sub>	External reset pulse duration	2.0	—	2.0	—	4.0	—	ns
t <sub>P<sub>TOE/DIS</sub></sub>	Input to output local product term output enable/disable	—	8.2	—	8.5	—	9.0	ns
t <sub>G<sub>P<sub>TOE/DIS</sub></sub></sub>	Input to output global product term output enable/disable	—	10.0	—	10.0	—	10.5	ns
t <sub>G<sub>OE/DIS</sub></sub>	Global OE input to output enable/disable	—	5.5	—	6.0	—	7.0	ns
t <sub>CW</sub>	Global clock width, high or low	1.8	—	2.0	—	2.8	—	ns
t <sub>GW</sub>	Global gate width low (for low transparent) or high (for high transparent)	1.8	—	2.0	—	2.8	—	ns
t <sub>WIR</sub>	Input register clock width, high or low	1.8	—	2.0	—	2.8	—	ns
f <sub>MAX</sub> <sup>4</sup>	Clock frequency with internal feedback	—	200	—	200	—	168	MHz
f <sub>MAX</sub> (Ext.)	clock frequency with external feedback, [1 / (t <sub>S</sub> + t <sub>CO</sub> )]	—	150	—	139	—	111	MHz

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.2.2

2. Measured using standard switching GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

## ispMACH 4000V/B/C Internal Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-5		-75		-10		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
<b>In/Out Delays</b>								
t <sub>IN</sub>	Input Buffer Delay	—	0.95	—	1.50	—	2.00	ns
t <sub>GOE</sub>	Global OE Pin Delay	—	4.04	—	6.04	—	7.04	ns
t <sub>GCLK_IN</sub>	Global Clock Input Buffer Delay	—	1.83	—	2.28	—	3.28	ns
t <sub>BUF</sub>	Delay through Output Buffer	—	1.00	—	1.50	—	1.50	ns
t <sub>EN</sub>	Output Enable Time	—	0.96	—	0.96	—	0.96	ns
t <sub>DIS</sub>	Output Disable Time	—	0.96	—	0.96	—	0.96	ns
<b>Routing/GLB Delays</b>								
t <sub>ROUTE</sub>	Delay through GRP	—	1.51	—	2.26	—	3.26	ns
t <sub>MCELL</sub>	Macrocell Delay	—	1.05	—	1.45	—	1.95	ns
t <sub>INREG</sub>	Input Buffer to Macrocell Register Delay	—	0.56	—	0.96	—	1.46	ns
t <sub>FBK</sub>	Internal Feedback Delay	—	0.00	—	0.00	—	0.00	ns
t <sub>PDb</sub>	5-PT Bypass Propagation Delay	—	1.54	—	2.24	—	3.24	ns
t <sub>PDi</sub>	Macrocell Propagation Delay	—	0.94	—	1.24	—	1.74	ns
<b>Register/Latch Delays</b>								
t <sub>S</sub>	D-Register Setup Time (Global Clock)	1.32	—	1.57	—	1.57	—	ns
t <sub>S_PT</sub>	D-Register Setup Time (Product Term Clock)	1.32	—	1.32	—	1.32	—	ns
t <sub>ST</sub>	T-Register Setup Time (Global Clock)	1.52	—	1.77	—	1.77	—	ns
t <sub>ST_PT</sub>	T-Register Setup Time (Product Term Clock)	1.32	—	1.32	—	1.32	—	ns
t <sub>H</sub>	D-Register Hold Time	1.68	—	2.93	—	3.93	—	ns
t <sub>HT</sub>	T-Register Hold Time	1.68	—	2.93	—	3.93	—	ns
t <sub>SIR</sub>	D-Input Register Setup Time (Global Clock)	1.52	—	1.57	—	1.57	—	ns
t <sub>SIR_PT</sub>	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	1.45	—	ns
t <sub>HIR</sub>	D-Input Register Hold Time (Global Clock)	0.68	—	1.18	—	1.18	—	ns
t <sub>HIR_PT</sub>	D-Input Register Hold Time (Product Term Clock)	0.68	—	1.18	—	1.18	—	ns
t <sub>COi</sub>	Register Clock to Output/Feedback MUX Time	—	0.52	—	0.67	—	1.17	ns
t <sub>CES</sub>	Clock Enable Setup Time	2.25	—	2.25	—	2.25	—	ns
t <sub>CEH</sub>	Clock Enable Hold Time	1.88	—	1.88	—	1.88	—	ns
t <sub>SL</sub>	Latch Setup Time (Global Clock)	1.32	—	1.57	—	1.57	—	ns
t <sub>SL_PT</sub>	Latch Setup Time (Product Term Clock)	1.32	—	1.32	—	1.32	—	ns
t <sub>HL</sub>	Latch Hold Time	1.17	—	1.17	—	1.17	—	ns
t <sub>GOi</sub>	Latch Gate to Output/Feedback MUX Time	—	0.33	—	0.33	—	0.33	ns
t <sub>PDLi</sub>	Propagation Delay through Transparent Latch to Output/Feedback MUX	—	0.25	—	0.25	—	0.25	ns
t <sub>SRI</sub>	Asynchronous Reset or Set to Output/Feedback MUX Delay	0.28	—	0.28	—	0.28	—	ns
t <sub>SRR</sub>	Asynchronous Reset or Set Recovery Time	1.67	—	1.67	—	1.67	—	ns
<b>Control Delays</b>								
t <sub>BCLK</sub>	GLB PT Clock Delay	—	1.12	—	1.12	—	0.62	ns
t <sub>PTCLK</sub>	Macrocell PT Clock Delay	—	0.87	—	0.87	—	0.87	ns
t <sub>BSR</sub>	GLB PT Set/Reset Delay	—	1.83	—	1.83	—	1.83	ns
t <sub>PTSR</sub>	Macrocell PT Set/Reset Delay	—	2.51	—	3.41	—	3.41	ns

## ispMACH 4000Z Internal Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-35		-37		-42		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
<b>In/Out Delays</b>								
t <sub>IN</sub>	Input Buffer Delay	—	0.75	—	0.80	—	0.75	ns
t <sub>GOE</sub>	Global OE Pin Delay	—	2.25	—	2.25	—	2.30	ns
t <sub>GCLK_IN</sub>	Global Clock Input Buffer Delay	—	1.60	—	1.60	—	1.95	ns
t <sub>BUF</sub>	Delay through Output Buffer	—	0.75	—	0.90	—	0.90	ns
t <sub>EN</sub>	Output Enable Time	—	2.25	—	2.25	—	2.50	ns
t <sub>DIS</sub>	Output Disable Time	—	1.35	—	1.35	—	2.50	ns
<b>Routing/GLB Delays</b>								
t <sub>ROUTE</sub>	Delay through GRP	—	1.60	—	1.60	—	2.15	ns
t <sub>MCELL</sub>	Macrocell Delay	—	0.65	—	0.75	—	0.85	ns
t <sub>INREG</sub>	Input Buffer to Macrocell Register Delay	—	0.91	—	1.00	—	1.00	ns
t <sub>FBK</sub>	Internal Feedback Delay	—	0.05	—	0.00	—	0.00	ns
t <sub>PDb</sub>	5-PT Bypass Propagation Delay	—	0.40	—	0.40	—	0.40	ns
t <sub>PDi</sub>	Macrocell Propagation Delay	—	0.25	—	0.25	—	0.65	ns
<b>Register/Latch Delays</b>								
t <sub>S</sub>	D-Register Setup Time (Global Clock)	0.80	—	0.95	—	0.90	—	ns
t <sub>S_PT</sub>	D-Register Setup Time (Product Term Clock)	1.35	—	1.95	—	1.90	—	ns
t <sub>ST</sub>	T-Register Setup Time (Global Clock)	1.00	—	1.15	—	1.10	—	ns
t <sub>ST_PT</sub>	T-register Setup Time (Product Term Clock)	1.55	—	1.75	—	2.10	—	ns
t <sub>H</sub>	D-Register Hold Time	1.40	—	1.55	—	1.80	—	ns
t <sub>HT</sub>	T-Register Hold Time	1.40	—	1.55	—	1.80	—	ns
t <sub>SIR</sub>	D-Input Register Setup Time (Global Clock)	0.94	—	0.90	—	1.50	—	ns
t <sub>SIR_PT</sub>	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	1.45	—	ns
t <sub>HIR</sub>	D-Input Register Hold Time (Global Clock)	1.06	—	1.20	—	1.10	—	ns
t <sub>HIR_PT</sub>	D-Input Register Hold Time (Product Term Clock)	0.88	—	1.00	—	1.00	—	ns
t <sub>COi</sub>	Register Clock to Output/Feedback MUX Time	—	0.65	—	0.70	—	0.65	ns
t <sub>CES</sub>	Clock Enable Setup Time	1.00	—	2.00	—	2.00	—	ns
t <sub>CEH</sub>	Clock Enable Hold Time	0.00	—	0.00	—	0.00	—	ns
t <sub>SL</sub>	Latch Setup Time (Global Clock)	0.80	—	0.95	—	0.90	—	ns
t <sub>SL_PT</sub>	Latch Setup Time (Product Term Clock)	1.55	—	1.95	—	1.90	—	ns
t <sub>HL</sub>	Latch Hold Time	1.40	—	1.80	—	1.80	—	ns
t <sub>GOi</sub>	Latch Gate to Output/Feedback MUX Time	—	0.40	—	0.33	—	0.33	ns
t <sub>PDLi</sub>	Propagation Delay through Transparent Latch to Output/Feedback MUX	—	0.30	—	0.25	—	0.25	ns
t <sub>SRI</sub>	Asynchronous Reset or Set to Output/Feedback MUX Delay	—	0.28	—	0.28	—	1.27	ns
t <sub>SRR</sub>	Asynchronous Reset or Set Recovery Delay	—	2.00	—	1.67	—	1.80	ns
<b>Control Delays</b>								
t <sub>BCLK</sub>	GLB PT Clock Delay	—	1.30	—	1.50	—	1.55	ns
t <sub>PTCLK</sub>	Macrocell PT Clock Delay	—	1.50	—	1.70	—	1.55	ns
t <sub>BSR</sub>	GLB PT Set/Reset Delay	—	1.10	—	1.83	—	1.83	ns
t <sub>PTSR</sub>	Macrocell PT Set/Reset Delay	—	1.22	—	2.02	—	1.83	ns

### ispMACH 4000Z Internal Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-45		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>P<sub>TOE</sub></sub>	Macrocell PT OE Delay	—	2.50	—	2.70	—	2.00	ns

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the timing model in this data sheet for further details. Timing v.2.2

**ispMACH 4000Z Timing Adders (Cont.)<sup>1</sup>**

Adder Type	Base Parameter	Description	-45		-5		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>									
t <sub>INDIO</sub>	t <sub>INREG</sub>	Input register delay	—	1.30	—	1.30	—	1.30	ns
t <sub>EXP</sub>	t <sub>MCELL</sub>	Product term expander delay	—	0.45	—	0.45	—	0.50	ns
t <sub>ORP</sub>	—	Output routing pool delay	—	0.40	—	0.40	—	0.40	ns
t <sub>BLA</sub>	t <sub>ROUTE</sub>	Additional block loading adder	—	0.05	—	0.05	—	0.05	ns
<b>t<sub>IOI</sub> Input Adjusters</b>									
LVTTTL_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
<b>t<sub>IOO</sub> Output Adjusters</b>									
LVTTTL_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t <sub>BUF</sub> , t <sub>EN</sub>	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.2.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

**ispMACH 4032V/B/C/Z and 4064V/B/C/Z Logic Signal Connections:  
48-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4032V/B/C/Z		ispMACH 4064V/B/C		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
33	1	B10	B <sup>^</sup> 10	D4	D <sup>^</sup> 2	D10	D <sup>^</sup> 5
34	1	B11	B <sup>^</sup> 11	D6	D <sup>^</sup> 3	D8	D <sup>^</sup> 4
35	-	TDO	-	TDO	-	TDO	-
36	-	VCC	-	VCC	-	VCC	-
37	-	GND	-	GND	-	GND	-
38	1	B12	B <sup>^</sup> 12	D8	D <sup>^</sup> 4	D6	D <sup>^</sup> 3
39	1	B13	B <sup>^</sup> 13	D10	D <sup>^</sup> 5	D4	D <sup>^</sup> 2
40	1	B14	B <sup>^</sup> 14	D12	D <sup>^</sup> 6	D2	D <sup>^</sup> 1
41	1	B15/GOE1	B <sup>^</sup> 15	D14/GOE1	D <sup>^</sup> 7	D0/GOE1	D <sup>^</sup> 0
42	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
43	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
44	0	A0/GOE0	A <sup>^</sup> 0	A0/GOE0	A <sup>^</sup> 0	A0/GOE0	A <sup>^</sup> 0
45	0	A1	A <sup>^</sup> 1	A2	A <sup>^</sup> 1	A1	A <sup>^</sup> 1
46	0	A2	A <sup>^</sup> 2	A4	A <sup>^</sup> 2	A2	A <sup>^</sup> 2
47	0	A3	A <sup>^</sup> 3	A6	A <sup>^</sup> 3	A4	A <sup>^</sup> 3
48	0	A4	A <sup>^</sup> 4	A8	A <sup>^</sup> 4	A6	A <sup>^</sup> 4

**ispMACH 4032Z and 4064Z Logic Signal Connections: 56-Ball csBGA**

Ball Number	Bank Number	ispMACH 4032Z		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
B1	-	TDI	-	TDI	-
C3	0	A5	A <sup>^</sup> 5	A8	A <sup>^</sup> 5
C1	0	A6	A <sup>^</sup> 6	A10	A <sup>^</sup> 6
D1	0	A7	A <sup>^</sup> 7	A11	A <sup>^</sup> 7
D3	0	GND (Bank 0)	-	GND (Bank 0)	-
E3	0	NC <sup>1</sup>	-	I <sup>1</sup>	-
E1	0	NC <sup>1</sup>	-	I <sup>1</sup>	-
F3	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
F1	0	A8	A <sup>^</sup> 8	B15	B <sup>^</sup> 7
G3	0	A9	A <sup>^</sup> 9	B12	B <sup>^</sup> 6
G1	0	A10	A <sup>^</sup> 10	B10	B <sup>^</sup> 5
H1	0	A11	A <sup>^</sup> 11	B8	B <sup>^</sup> 4
J1	0	NC	-	I	-
K1	-	TCK	-	TCK	-
K2	-	VCC	-	VCC	-
H3	-	GND	-	GND	-
K3	-	NC <sup>1</sup>	-	I <sup>1</sup>	-
K4	0	A12	A <sup>^</sup> 12	B6	B <sup>^</sup> 3
H4	0	A13	A <sup>^</sup> 13	B4	B <sup>^</sup> 2
H5	0	A14	A <sup>^</sup> 14	B2	B <sup>^</sup> 1

**ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections:  
100-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4064V/B/C/Z		ispMACH 4128V/B/C/Z		ispMACH 4256V/B/C/Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
83	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
84	1	D3	D <sup>3</sup>	H6	H <sup>3</sup>	P12	P <sup>3</sup>
85	1	D2	D <sup>2</sup>	H4	H <sup>2</sup>	P10	P <sup>2</sup>
86	1	D1	D <sup>1</sup>	H2	H <sup>1</sup>	P6	P <sup>1</sup>
87	1	D0/GOE1	D <sup>0</sup>	H0/GOE1	H <sup>0</sup>	P2/OE1	P <sup>0</sup>
88	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
89	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
90	-	VCC	-	VCC	-	VCC	-
91	0	A0/GOE0	A <sup>0</sup>	A0/GOE0	A <sup>0</sup>	A2/GOE0	A <sup>0</sup>
92	0	A1	A <sup>1</sup>	A2	A <sup>1</sup>	A6	A <sup>1</sup>
93	0	A2	A <sup>2</sup>	A4	A <sup>2</sup>	A10	A <sup>2</sup>
94	0	A3	A <sup>3</sup>	A6	A <sup>3</sup>	A12	A <sup>3</sup>
95	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
96	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
97	0	A4	A <sup>4</sup>	A8	A <sup>4</sup>	B2	B <sup>0</sup>
98	0	A5	A <sup>5</sup>	A10	A <sup>5</sup>	B6	B <sup>1</sup>
99	0	A6	A <sup>6</sup>	A12	A <sup>6</sup>	B10	B <sup>2</sup>
100	0	A7	A <sup>7</sup>	A14	A <sup>7</sup>	B12	B <sup>3</sup>

\*This pin is input only.

**ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP**

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
1	0	GND	-
2	0	TDI	-
3	0	VCCO (Bank 0)	-
4	0	B0	B <sup>0</sup>
5	0	B1	B <sup>1</sup>
6	0	B2	B <sup>2</sup>
7	0	B4	B <sup>3</sup>
8	0	B5	B <sup>4</sup>
9	0	B6	B <sup>5</sup>
10	0	GND (Bank 0)	-
11	0	B8	B <sup>6</sup>
12	0	B9	B <sup>7</sup>
13	0	B10	B <sup>8</sup>
14	0	B12	B <sup>9</sup>
15	0	B13	B <sup>10</sup>
16	0	B14	B <sup>11</sup>
17	0	VCCO (Bank 0)	-
18	0	C14	C <sup>11</sup>

**ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
19	0	C13	C^10
20	0	C12	C^9
21	0	C10	C^8
22	0	C9	C^7
23	0	C8	C^6
24	0	GND (Bank 0)	-
25	0	C6	C^5
26	0	C5	C^4
27	0	C4	C^3
28	0	C2	C^2
29	0	C0	C^0
30	0	VCCO (Bank 0)	-
31	0	TCK	-
32	0	VCC	-
33	0	GND	-
34	0	D14	D^11
35	0	D13	D^10
36	0	D12	D^9
37	0	D10	D^8
38	0	D9	D^7
39	0	D8	D^6
40	0	GND (Bank 0)	-
41	0	VCCO (Bank 0)	-
42	0	D6	D^5
43	0	D5	D^4
44	0	D4	D^3
45	0	D2	D^2
46	0	D1	D^1
47	0	D0	D^0
48	0	CLK1/I	-
49	1	GND (Bank 1)	-
50	1	CLK2/I	-
51	1	VCC	-
52	1	E0	E^0
53	1	E1	E^1
54	1	E2	E^2
55	1	E4	E^3
56	1	E5	E^4
57	1	E6	E^5
58	1	VCCO (Bank 1)	-
59	1	GND (Bank 1)	-
60	1	E8	E^6
61	1	E9	E^7

**ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
62	1	E10	E^8
63	1	E12	E^9
64	1	E14	E^11
65	1	GND	-
66	1	TMS	-
67	1	VCCO (Bank 1)	-
68	1	F0	F^0
69	1	F1	F^1
70	1	F2	F^2
71	1	F4	F^3
72	1	F5	F^4
73	1	F6	F^5
74	1	GND (Bank 1)	-
75	1	F8	F^6
76	1	F9	F^7
77	1	F10	F^8
78	1	F12	F^9
79	1	F13	F^10
80	1	F14	F^11
81	1	VCCO (Bank 1)	-
82	1	G14	G^11
83	1	G13	G^10
84	1	G12	G^9
85	1	G10	G^8
86	1	G9	G^7
87	1	G8	G^6
88	1	GND (Bank 1)	-
89	1	G6	G^5
90	1	G5	G^4
91	1	G4	G^3
92	1	G2	G^2
93	1	G0	G^0
94	1	VCCO (Bank 1)	-
95	1	TDO	-
96	1	VCC	-
97	1	GND	-
98	1	H14	H^11
99	1	H13	H^10
100	1	H12	H^9
101	1	H10	H^8
102	1	H9	H^7
103	1	H8	H^6
104	1	GND (Bank 1)	-

**ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
105	1	VCCO (Bank 1)	-
106	1	H6	H <sup>5</sup>
107	1	H5	H <sup>4</sup>
108	1	H4	H <sup>3</sup>
109	1	H2	H <sup>2</sup>
110	1	H1	H <sup>1</sup>
111	1	H0/GOE1	H <sup>0</sup>
112	1	CLK3/I	-
113	0	GND (Bank 0)	-
114	0	CLK0/I	-
115	0	VCC	-
116	0	A0/GOE0	A <sup>0</sup>
117	0	A1	A <sup>1</sup>
118	0	A2	A <sup>2</sup>
119	0	A4	A <sup>3</sup>
120	0	A5	A <sup>4</sup>
121	0	A6	A <sup>5</sup>
122	0	VCCO (Bank 0)	-
123	0	GND (Bank 0)	-
124	0	A8	A <sup>6</sup>
125	0	A9	A <sup>7</sup>
126	0	A10	A <sup>8</sup>
127	0	A12	A <sup>9</sup>
128	0	A14	A <sup>11</sup>

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:  
132-Ball csBGA**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
B1	-	GND	-	GND	-	GND	-
B2	-	TDI	-	TDI	-	TDI	-
C1	0	NC	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
C3	0	NC	-	B0	B <sup>0</sup>	C12	C <sup>6</sup>
C2	0	A8	A <sup>8</sup>	B1	B <sup>1</sup>	C10	C <sup>5</sup>
D1	0	A9	A <sup>9</sup>	B2	B <sup>2</sup>	C8	C <sup>4</sup>
D3	0	A10	A <sup>10</sup>	B4	B <sup>3</sup>	C6	C <sup>3</sup>
D2	0	A11	A <sup>11</sup>	B5	B <sup>4</sup>	C4	C <sup>2</sup>
E1	0	NC	-	B6	B <sup>5</sup>	C2	C <sup>1</sup>
E2	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:  
132-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
P8	1	NC <sup>1</sup>	-	NC <sup>1</sup>	-	I <sup>1</sup>	-
M8	1	NC	-	E0	E <sup>0</sup>	I2	I <sup>1</sup>
P9	1	C0	C <sup>0</sup>	E1	E <sup>1</sup>	I4	I <sup>2</sup>
N9	1	C1	C <sup>1</sup>	E2	E <sup>2</sup>	I6	I <sup>3</sup>
M9	1	C2	C <sup>2</sup>	E4	E <sup>3</sup>	I8	I <sup>4</sup>
N10	1	C3	C <sup>3</sup>	E5	E <sup>4</sup>	I10	I <sup>5</sup>
P10	1	NC	-	E6	E <sup>5</sup>	I12	I <sup>6</sup>
M10	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
N11	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
P11	1	NC	-	E8	E <sup>6</sup>	J2	J <sup>1</sup>
M11	1	C4	C <sup>4</sup>	E9	E <sup>7</sup>	J4	J <sup>2</sup>
P12	1	C5	C <sup>5</sup>	E10	E <sup>8</sup>	J6	J <sup>3</sup>
N12	1	C6	C <sup>6</sup>	E12	E <sup>9</sup>	J8	J <sup>4</sup>
P13	1	C7	C <sup>7</sup>	E13	E <sup>10</sup>	J10	J <sup>5</sup>
P14	1	NC	-	E14	E <sup>11</sup>	J12	J <sup>6</sup>
N14	-	GND	-	GND	-	GND	-
N13	-	TMS	-	TMS	-	TMS	-
M14	1	NC	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
M12	1	NC	-	F0	F <sup>0</sup>	K12	K <sup>6</sup>
M13	1	C8	C <sup>8</sup>	F1	F <sup>1</sup>	K10	K <sup>5</sup>
L14	1	C9	C <sup>9</sup>	F2	F <sup>2</sup>	K8	K <sup>4</sup>
L12	1	C10	C <sup>10</sup>	F4	F <sup>3</sup>	K6	K <sup>3</sup>
L13	1	C11	C <sup>11</sup>	F5	F <sup>4</sup>	K4	K <sup>2</sup>
K14	1	NC	-	F6	F <sup>5</sup>	K2	K <sup>1</sup>
K13	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
K12	1	NC	-	F8	F <sup>6</sup>	L12	L <sup>6</sup>
J13	1	C12	C <sup>12</sup>	F9	F <sup>7</sup>	L10	L <sup>5</sup>
J14	1	C13	C <sup>13</sup>	F10	F <sup>8</sup>	L8	L <sup>4</sup>
J12	1	C14	C <sup>14</sup>	F12	F <sup>9</sup>	L6	L <sup>3</sup>
H14	1	C15	C <sup>15</sup>	F13	F <sup>10</sup>	L4	L <sup>2</sup>
H13	1	I	-	F14	F <sup>11</sup>	L2	L <sup>1</sup>
H12	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
G13	1	NC	-	G14	G <sup>11</sup>	M2	M <sup>1</sup>
G14	1	NC	-	G13	G <sup>10</sup>	M4	M <sup>2</sup>
G12	1	D15	D <sup>15</sup>	G12	G <sup>9</sup>	M6	M <sup>3</sup>
F14	1	D14	D <sup>14</sup>	G10	G <sup>8</sup>	M8	M <sup>4</sup>
F13	1	D13	D <sup>13</sup>	G9	G <sup>7</sup>	M10	M <sup>5</sup>
F12	1	D12	D <sup>12</sup>	G8	G <sup>6</sup>	M12	M <sup>6</sup>
E13	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
E14	1	NC	-	G6	G <sup>5</sup>	N2	N <sup>1</sup>
E12	1	D11	D <sup>11</sup>	G5	G <sup>4</sup>	N4	N <sup>2</sup>

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
101	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
102	1	L14	L^7	AX14	AX^7	GX14	GX^7
103	1	L12	L^6	AX12	AX^6	GX12	GX^6
104	1	L10	L^5	AX10	AX^5	GX10	GX^5
105	1	L8	L^4	AX8	AX^4	GX8	GX^4
106	1	L6	L^3	AX6	AX^3	GX6	GX^3
107	1	L4	L^2	AX4	AX^2	GX4	GX^2
108	1	L2	L^1	AX2	AX^1	GX2	GX^1
109	1	L0	L^0	AX0	AX^0	GX0	GX^0
110	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
111	1	M0	M^0	DX0	DX^0	JX0	JX^0
112	1	M2	M^1	DX2	DX^1	JX2	JX^1
113	1	M4	M^2	DX4	DX^2	JX4	JX^2
114	1	M6	M^3	DX6	DX^3	JX6	JX^3
115	1	M8	M^4	DX8	DX^4	JX8	JX^4
116	1	M10	M^5	DX10	DX^5	JX10	JX^5
117	1	M12	M^6	DX12	DX^6	JX12	JX^6
118	1	M14	M^7	DX14	DX^7	JX14	JX^7
119	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
120	1	N0	N^0	FX0	FX^0	NX0	NX^0
121	1	N2	N^1	FX2	FX^1	NX2	NX^1
122	1	N4	N^2	FX4	FX^2	NX4	NX^2
123	1	N6	N^3	FX6	FX^3	NX6	NX^3
124	1	N8	N^4	FX8	FX^4	NX8	NX^4
125	1	N10	N^5	FX10	FX^5	NX10	NX^5
126	1	N12	N^6	FX12	FX^6	NX12	NX^6
127	1	N14	N^7	FX14	FX^7	NX14	NX^7
128	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
129	-	TDO	-	TDO	-	TDO	-
130	-	VCC	-	VCC	-	VCC	-
131	-	NC	-	NC	-	NC	-
132	-	NC	-	NC	-	NC	-
133	-	NC	-	NC	-	NC	-
134	-	GND	-	GND	-	GND	-
135	1	O14	O^7	GX14	GX^7	OX14	OX^7
136	1	O12	O^6	GX12	GX^6	OX12	OX^6
137	1	O10	O^5	GX10	GX^5	OX10	OX^5
138	1	O8	O^4	GX8	GX^4	OX8	OX^4
139	1	O6	O^3	GX6	GX^3	OX6	OX^3
140	1	O4	O^2	GX4	GX^2	OX4	OX^2
141	1	O2	O^1	GX2	GX^1	OX2	OX^1

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:  
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
R5	0	NC	-	NC	-	NC	-	L4	L^1
T5	0	NC	-	NC	-	I2	I^1	L8	L^2
R6	0	NC	-	NC	-	I0	I^0	L12	L^3
T6	0	NC	-	H14	H^9	G12	G^6	M8	M^2
N7	0	NC	-	H12	H^8	G14	G^7	M12	M^3
P7	0	H14	H^7	H10	H^7	L14	L^7	P14	P^7
R7	0	H12	H^6	H9	H^6	L12	L^6	P12	P^6
L8	0	H10	H^5	H8	H^5	L10	L^5	P10	P^5
T7	0	H8	H^4	H6	H^4	L8	L^4	P8	P^4
M8	0	H6	H^3	H4	H^3	L6	L^3	P6	P^3
N8	0	H4	H^2	H2	H^2	L4	L^2	P4	P^2
R8	0	H2	H^1	H1	H^1	L2	L^1	P2	P^1
P8	0	H0	H^0	H0	H^0	L0	L^0	P0	P^0
-	-	GND	-	GND	-	GND	-	GND	-
T8	0	CLK1/I	-	CLK1/I	-	CLK1/I	-	CLK1/I	-
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
N9	1	CLK2/I	-	CLK2/I	-	CLK2/I	-	CLK2/I	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
P9	1	I0	I^0	I0	I^0	M0	M^0	AX0	AX^0
R9	1	I2	I^1	I1	I^1	M2	M^1	AX2	AX^1
T9	1	I4	I^2	I2	I^2	M4	M^2	AX4	AX^2
T10	1	I6	I^3	I4	I^3	M6	M^3	AX6	AX^3
R10	1	I8	I^4	I6	I^4	M8	M^4	AX8	AX^4
M9	1	I10	I^5	I8	I^5	M10	M^5	AX10	AX^5
P10	1	I12	I^6	I9	I^6	M12	M^6	AX12	AX^6
L9	1	I14	I^7	I10	I^7	M14	M^7	AX14	AX^7
N10	1	NC	-	I12	I^8	BX14	BX^7	DX0	DX^0
T11	1	NC	-	I14	I^9	BX12	BX^6	DX4	DX^1
R11	1	NC	-	NC	-	P0	P^0	EX0	EX^0
T12	1	NC	-	NC	-	P2	P^1	EX4	EX^1
N12	1	NC	-	NC	-	NC	-	EX8	EX^2
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
R12	1	NC	-	NC	-	NC	-	EX12	EX^3
T13	1	NC	-	J0	J^0	BX10	BX^5	DX8	DX^2
P12	1	NC	-	J1	J^1	BX8	BX^4	DX12	DX^3
M10	1	J0	J^0	J2	J^2	N0	N^0	BX0	BX^0
R13	1	J2	J^1	J4	J^3	N2	N^1	BX2	BX^1
L10	1	J4	J^2	J6	J^4	N4	N^2	BX4	BX^2
T14	1	J6	J^3	J8	J^5	N6	N^3	BX6	BX^3
M11	1	J8	J^4	J9	J^6	N8	N^4	BX8	BX^4

## ispMACH 4000B (2.5V) Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4256B	LC4256B-3FT256AC	256	2.5	3	ftBGA	256	128	C
	LC4256B-5FT256AC	256	2.5	5	ftBGA	256	128	C
	LC4256B-75FT256AC	256	2.5	7.5	ftBGA	256	128	C
	LC4256B-3FT256BC	256	2.5	3	ftBGA	256	160	C
	LC4256B-5FT256BC	256	2.5	5	ftBGA	256	160	C
	LC4256B-75FT256BC	256	2.5	7.5	ftBGA	256	160	C
	LC4256B-3F256AC <sup>1</sup>	256	2.5	3	fpBGA	256	128	C
	LC4256B-5F256AC <sup>1</sup>	256	2.5	5	fpBGA	256	128	C
	LC4256B-75F256AC <sup>1</sup>	256	2.5	7.5	fpBGA	256	128	C
	LC4256B-3F256BC <sup>1</sup>	256	2.5	3	fpBGA	256	160	C
	LC4256B-5F256BC <sup>1</sup>	256	2.5	5	fpBGA	256	160	C
	LC4256B-75F256BC <sup>1</sup>	256	2.5	7.5	fpBGA	256	160	C
	LC4256B-3T176C	256	2.5	3	TQFP	176	128	C
	LC4256B-5T176C	256	2.5	5	TQFP	176	128	C
	LC4256B-75T176C	256	2.5	7.5	TQFP	176	128	C
	LC4256B-3T100C	256	2.5	3	TQFP	100	64	C
LC4256B-5T100C	256	2.5	5	TQFP	100	64	C	
LC4256B-75T100C	256	2.5	7.5	TQFP	100	64	C	
LC4384B	LC4384B-35FT256C	384	2.5	3.5	ftBGA	256	192	C
	LC4384B-5FT256C	384	2.5	5	ftBGA	256	192	C
	LC4384B-75FT256C	384	2.5	7.5	ftBGA	256	192	C
	LC4384B-35F256C <sup>1</sup>	384	2.5	3.5	fpBGA	256	192	C
	LC4384B-5F256C <sup>1</sup>	384	2.5	5	fpBGA	256	192	C
	LC4384B-75F256C <sup>1</sup>	384	2.5	7.5	fpBGA	256	192	C
	LC4384B-35T176C	384	2.5	3.5	TQFP	176	128	C
	LC4384B-5T176C	384	2.5	5	TQFP	176	128	C
	LC4384B-75T176C	384	2.5	7.5	TQFP	176	128	C
LC4512B	LC4512B-35FT256C	512	2.5	3.5	ftBGA	256	208	C
	LC4512B-5FT256C	512	2.5	5	ftBGA	256	208	C
	LC4512B-75FT256C	512	2.5	7.5	ftBGA	256	208	C
	LC4512B-35F256C <sup>1</sup>	512	2.5	3.5	fpBGA	256	208	C
	LC4512B-5F256C <sup>1</sup>	512	2.5	5	fpBGA	256	208	C
	LC4512B-75F256C <sup>1</sup>	512	2.5	7.5	fpBGA	256	208	C
	LC4512B-35T176C	512	2.5	3.5	TQFP	176	128	C
	LC4512B-5T176C	512	2.5	5	TQFP	176	128	C
	LC4512B-75T176C	512	2.5	7.5	TQFP	176	128	C

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

## ispMACH 4000B (2.5V) Lead-Free Commercial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032B	LC4032B-25TN48C	32	2.5	2.5	Lead-Free TQFP	48	32	C
	LC4032B-5TN48C	32	2.5	5	Lead-Free TQFP	48	32	C
	LC4032B-75TN48C	32	2.5	7.5	Lead-Free TQFP	48	32	C
	LC4032B-25TN44C	32	2.5	2.5	Lead-Free TQFP	44	30	C
	LC4032B-5TN44C	32	2.5	5	Lead-Free TQFP	44	30	C
	LC4032B-75TN44C	32	2.5	7.5	Lead-Free TQFP	44	30	C
LC4064B	LC4064B-25TN100C	64	2.5	2.5	Lead-Free TQFP	100	64	C
	LC4064B-5TN100C	64	2.5	5	Lead-Free TQFP	100	64	C
	LC4064B-75TN100C	64	2.5	7.5	Lead-Free TQFP	100	64	C
	LC4064B-25TN48C	64	2.5	2.5	Lead-Free TQFP	48	32	C
	LC4064B-5TN48C	64	2.5	5	Lead-Free TQFP	48	32	C
	LC4064B-75TN48C	64	2.5	7.5	Lead-Free TQFP	48	32	C
	LC4064B-25TN44C	64	2.5	2.5	Lead-Free TQFP	44	30	C
	LC4064B-5TN44C	64	2.5	5	Lead-Free TQFP	44	30	C
LC4128B	LC4128B-27TN128C	128	2.5	2.7	Lead-Free TQFP	128	92	C
	LC4128B-5TN128C	128	2.5	5	Lead-Free TQFP	128	92	C
	LC4128B-75TN128C	128	2.5	7.5	Lead-Free TQFP	128	92	C
	LC4128B-27TN100C	128	2.5	2.7	Lead-Free TQFP	100	92	C
	LC4128B-5TN100C	128	2.5	5	Lead-Free TQFP	100	92	C
	LC4128B-75TN100C	128	2.5	7.5	Lead-Free TQFP	100	92	C
LC4256B	LC4256B-3FTN256AC	256	2.5	3	Lead-Free ftBGA	256	128	C
	LC4256B-5FTN256AC	256	2.5	5	Lead-Free ftBGA	256	128	C
	LC4256B-75FTN256AC	256	2.5	7.5	Lead-Free ftBGA	256	128	C
	LC4256B-3FTN256BC	256	2.5	3	Lead-Free ftBGA	256	160	C
	LC4256B-5FTN256BC	256	2.5	5	Lead-Free ftBGA	256	160	C
	LC4256B-75FTN256BC	256	2.5	7.5	Lead-Free ftBGA	256	160	C
	LC4256B-3FN256AC <sup>1</sup>	256	2.5	3	Lead-Free fpBGA	256	128	C
	LC4256B-5FN256AC <sup>1</sup>	256	2.5	5	Lead-Free fpBGA	256	128	C
	LC4256B-75FN256AC <sup>1</sup>	256	2.5	7.5	Lead-Free fpBGA	256	128	C
	LC4256B-3FN256BC <sup>1</sup>	256	2.5	3	Lead-Free fpBGA	256	160	C
	LC4256B-5FN256BC <sup>1</sup>	256	2.5	5	Lead-Free fpBGA	256	160	C
	LC4256B-75FN256BC <sup>1</sup>	256	2.5	7.5	Lead-Free fpBGA	256	160	C
	LC4256B-3TN176C	256	2.5	3	Lead-Free TQFP	176	128	C
	LC4256B-5TN176C	256	2.5	5	Lead-Free TQFP	176	128	C
	LC4256B-75TN176C	256	2.5	7.5	Lead-Free TQFP	176	128	C
	LC4256B-3TN100C	256	2.5	3	Lead-Free TQFP	100	64	C
LC4256B-5TN100C	256	2.5	5	Lead-Free TQFP	100	64	C	
LC4256B-75TN100C	256	2.5	7.5	Lead-Free TQFP	100	64	C	

**Revision History (Cont.)**

Date	Version	Change Summary
January 2004	20z	ispMACH 4000Z data sheet status changed from preliminary to final. Documents production release of the ispMACH 4256Z device.
		Added new feature - ispMACH 4000Z supports operation down to 1.6V.
		Added lead-free packaging ordering part numbers for the ispMACH 4000Z/C/V devices.
April 2004	21z	Updated $I_{PU}$ (I/O Weak Pull-up Resistor Current) max. specification for the ispMACH 4000V/B/C; -150 $\mu$ A to -200 $\mu$ A.
November 2004	22z	Added User Electronic Signature section.
		Added ispMACH 4000B (2.5V) Lead-Free Ordering Part Numbers.
December 2004	22z.1	Updated Further Information section.
February 2006	22z.2	Clarification to ispMACH 4000Z Input Leakage ( $I_{IH}$ ) specification.
March 2007	22.3	Updated ispMACH 4000 Introduction section.
		Updated Signal Descriptions table.
June 2007	22.4	Updated Features bullets to include reference to "LA" automotive data sheet under the "Broad Device Offering" bullet.
		Added footnote 1 to Part Number Description to reference the "LA" automotive data sheet.
		Changed device temperature references from 'Automotive' to "Extended Temperature" for non-AEC-Q100 qualified devices.
November 2007	23.0	Added 256-ftBGA package Ordering Part Number information per PCN#14A-07.
May 2009	23.1	Correction to $t_{CW}$ , $t_{GW}$ , $t_{WIR}$ and $f_{MAX}$ parameters in ispMACH 4000Z External Switching Characteristics table.
		Correction to $t_{CW}$ , $t_{GW}$ , $t_{WIR}$ and $f_{MAX}$ parameters in ispMACH 4000V/B/C External Switching Characteristics table.